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June 2014

NC7SV126
TinyLogic® ULP-A Buffer with Three-State Output

Features

- 0.9 V to 3.6 V V_{CC} Supply Operation
- 3.6 V Over-Voltage Tolerant I/O's at V_{CC} from 0.9 V to 3.6 V
- Extremely High Speed t_{PD}
  - 1.0 ns: Typical for 2.7 V to 3.6 V V_{CC}
  - 1.8 ns: Typical for 2.3 V to 2.7 V V_{CC}
  - 3.0 ns: Typical for 1.65 V to 1.95 V V_{CC}
  - 3.5 ns: Typical for 1.4 V to 1.6 V V_{CC}
  - 6.0 ns: Typical for 1.1 V to 1.3 V V_{CC}
  - 13.0 ns:Typical for 0.9 V V_{CC}
- Power-Off High-Impedance Inputs and Outputs
- High Static Drive (I_{OH}/I_{OL})
  - ±24 mA at 3.00 V V_{CC}
  - ±18 mA at 2.30 V V_{CC}
  - ±6 mA at 1.65 V V_{CC}
  - ±4 mA at 1.4V V_{CC}
  - ±2 mA at 1.1 V V_{CC}
  - ±0.1 mA at 0.9 V V_{CC}
- Uses Proprietary Quiet Series™ Noise/EMI Reduction Circuitry
- Ultra-Small MicroPak™ Leadfree Package
- Ultra-Low Dynamic Power

Description

The NC7SV126 is a single buffer with 3-STATE output from Fairchild's Ultra-Low Power-A (ULP-A) Series of TinyLogic®. ULP-A is ideal for applications that require extreme high speed, high drive, and low power. This product is designed for a wide low-voltage operating range (0.9 V to 3.6 V V_{CC}) and applications that require more drive and speed than the TinyLogic® ULP series, but still offer best in class low power operation.

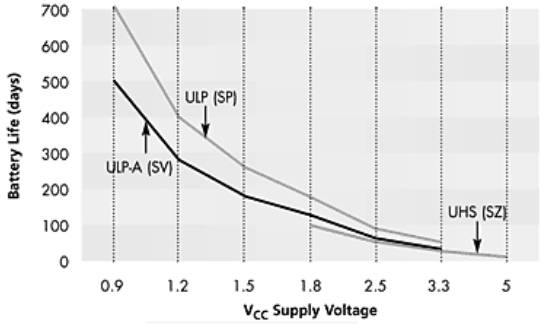
The NC7SV126 is uniquely designed for optimized power and speed, and is fabricated with an advanced CMOS technology to achieve high-speed operation while maintaining low CMOS power dissipation.

Ordering Information

Part Number	Top Mark	Package	Packing Method
NC7SV126P5X	V26	5-Lead SC70, EIAJ SC-88a, 1.25 mm Wide	3000 Units on Tape & Reel
NC7SV126L6X	H7	6-Lead MicroPak™, 1.00 mm Wide	5000 Units on Tape & Reel

For Fairchild's definition of "green" Eco Status, please visit: http://www.fairchildsemi.com/company/green/rohs_green.html.

Battery Life



Notes:

1. TinyLogic® ULP and ULP-A with up to 50% less power consumption can extend your battery life significantly.
   Battery Life = $(V_{battery} \bullet I_{battery} \bullet .9)/(P_{device})/24hrs/day$
   Where, $P_{device} = (I_{CC} \bullet V_{CC}) + (C_{PD} + C_L) \bullet V_{CC2} \bullet f$.
2. Assumes ideal 3.6 V Lithium Ion battery with current rating of 900 mAH and derated 90% and device frequency at 10 MHz, with C_L = 15 pF load.

Figure 1. Battery Life vs. V_{CC} Supply Voltage

Connection Diagram

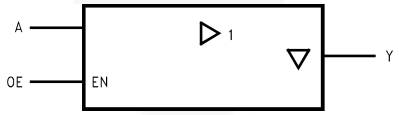


Figure 2. Logic Symbol

Pin Configurations

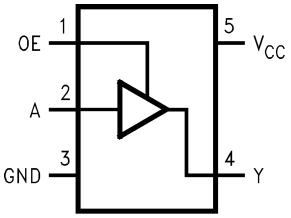


Figure 3. SC70 (Top View)

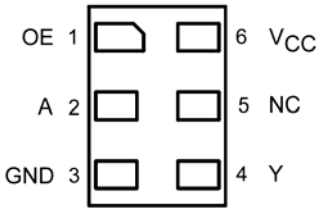


Figure 4. MicroPak (Top Through View)

Pin Definitions

Pin # SC70	Pin # MicroPak	Name	Description
1	1	OE	Input
2	2	A	Input
3	3	GND	Ground
4	4	Y	Output
5	6	V_{CC}	Supply Voltage
	5	NC	No Connect

Function Table

Inputs		Output
OE	**A**	**Out Y**
H	L	L
H	H	H
L	X	Z

H = HIGH Logic Level
L = LOW Logic Level
X = HIGH or LOW Logic Level
Z = HIGH Impedance State

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
V_{CC}	Supply Voltage		-0.5	4.6	V
V_{IN}	DC Input Voltage		-0.5	4.6	V
V_{OUT}	DC Output Voltage	HIGH or LOW State[3]	-0.5	V_{CC} + 0.5	V
		V_{CC} = 0 V	-0.5	4.6	
I_{IK}	DC Input Diode Current	V_{IN} < 0 V		-50	mA
I_{OK}	DC Output Diode Current	V_{OUT} < 0 V		-50	mA
		V_{OUT} > V_{CC}		+50	
I_{OH}/I_{OL}	DC Output Source/Sink Current			±50	mA
I_{CC} or I_{GND}	DC V_{CC} or Ground Current per Supply Pin			±50	mA
T_{STG}	Storage Temperature Range		-65	+150	°C
P_D	Power Dissipation at +85°C	SC70-5		150	mW
		MicroPak-6		130	
ESD	Human Body Model, JEDEC:JESD22-A114			4000	V
	Charge Device Model, JEDEC:JESD22-C101			2000	

Note:

3. IO absolute maximum rating must be observed.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit
V_{CC}	Supply Voltage Operating		0.9	3.6	V
V_{IN}	Input Voltage		0	3.6	V
V_{OUT}	Output Voltage	V_{CC} = 0 V	0	3.6	V
		HIGH or LOW State	0	V_{CC}	
I_{OH}/I_{OL}	Output Current	V_{CC} = 3.0 V to 3.6 V		±24	mA
		V_{CC} = 2.3 V to 3.6 V		±18	
		V_{CC} = 1.65 V to 1.95 V		±6	
		V_{CC} = 1.4 V to 1.6 V		±4	
		V_{CC} = 1.1 V to 1.3 V		±2	
		V_{CC} = 0.9 V		±0.1	
T_A	Operating Temperature, Free Air		-40	+85	°C
$\Delta t/\Delta V$	Minimum Input Edge Rate	V_{IN} = 0.8 V to 2.0, V_{CC} = 3.0 V		10	ns/V
θ_{JA}	Thermal Resistance	SC70-5		425	°C/W
		MicroPak-6		500	

Note:

4. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V_{CC}	Conditions	T_A=25°C		T_A=-40 to 85°C		Units
				Min.	Max.	Min.	Max.	
V_{IH}	HIGH Level Input Voltage	0.90		.65 x V_{CC}		.65 x V_{CC}		V
		1.10 ≤ V_{CC} ≤ 1.30		.65 x V_{CC}		.65 x V_{CC}		
		1.40 ≤ V_{CC} ≤ 1.60		.65 x V_{CC}		.65 x V_{CC}		
		1.65 ≤ V_{CC} ≤ 1.95		.65 x V_{CC}		.65 x V_{CC}		
		2.30 ≤ V_{CC} ≤ 2.70		1.6		1.6		
		2.70 ≤ V_{CC} ≤ 3.60		2.0		2.0		
V_{IL}	LOW Level Input Voltage	0.90			.35 x V_{CC}		.35 x V_{CC}	V
		1.10 ≤ V_{CC} ≤ 1.30			.35 x V_{CC}		.35 x V_{CC}	
		1.40 ≤ V_{CC} ≤ 1.60			.35 x V_{CC}		.35 x V_{CC}	
		1.65 ≤ V_{CC} ≤ 1.95			.35 x V_{CC}		.35 x V_{CC}	
		2.30 ≤ V_{CC} ≤ 2.70			0.7		0.7	
		2.70 ≤ V_{CC} ≤ 3.60			0.8		0.8	
V_{OH}	HIGH Level Output Voltage	0.90	I_{OH}=-100 µA	V_{CC}-0.1		V_{CC}-0.1		V
		1.10 ≤ V_{CC} ≤ 1.30		V_{CC}-0.1		V_{CC}-0.1		
		1.40 ≤ V_{CC} ≤ 1.60		V_{CC}-0.2		V_{CC}-0.2		
		1.65 ≤ V_{CC} ≤ 1.95		V_{CC}-0.2		V_{CC}-0.2		
		2.30 ≤ V_{CC} ≤ 2.70		V_{CC}-0.2		V_{CC}-0.2		
		2.70 ≤ V_{CC} ≤ 3.60		V_{CC}-0.2		V_{CC}-0.2		
		1.10 ≤ V_{CC} ≤ 1.30	I_{OH}=-2 mA	.75 x V_{CC}		.75 x V_{CC}		
		1.40 ≤ V_{CC} ≤ 1.60	I_{OH}=-4 mA	.75 x V_{CC}		.75 x V_{CC}		
		1.65 ≤ V_{CC} ≤ 1.95	I_{OH}=-6 mA	1.25		1.25		
		2.30 ≤ V_{CC} ≤ 2.70		2.0		2.0		
		2.30 ≤ V_{CC} ≤ 2.70	I_{OH}=-12 mA	1.8		1.8		
		2.70≤ V_{CC} ≤ 3.60		2.2		2.2		
		2.30 ≤ V_{CC} ≤ 2.70	I_{OH}=-18 mA	1.7		1.7		
		2.70 ≤ V_{CC} ≤ 3.60		2.4		2.4		
		2.70 ≤ V_{CC} ≤ 3.60	I_{OH}=-24 mA	2.2		2.2		

Continued on following page…

DC Electrical Characteristics (Continued)

Symbol	Parameter	V_{CC}	Conditions	T_A=25°C		T_A=-40 to 85°C		Units
				Min.	Max.	Min.	Max.	
V_{OL}	LOW Level Output Voltage	0.90	I_{OL}=100 µA		0.1		0.1	V
		1.10 ≤ V_{CC} ≤ 1.30			0.1		0.1	
		1.40 ≤ V_{CC} ≤ 1.60			0.2		0.2	
		1.65 ≤ V_{CC} ≤ 1.95			0.2		0.2	
		2.30 ≤ V_{CC} ≤ 2.70			0.2		0.2	
		2.70 ≤ V_{CC} ≤ 3.60			0.2		0.2	
		1.10 ≤ V_{CC} ≤ 1.30	I_{OL}=2 mA		0.25 x V_{CC}		0.25 x V_{CC}	
		1.40 ≤ V_{CC} ≤ 1.60	I_{OL}=4 mA		0.25 x V_{CC}		0.25 x V_{CC}	
		1.65 ≤ V_{CC} ≤ 1.95	I_{OL}=6 mA		0.3		0.3	
		2.30 ≤ V_{CC} ≤ 2.70	I_{OL}=12 mA		0.4		0.4	
		2.70 ≤ V_{CC} ≤ 3.60			0.4		0.4	
		2.30≤ V_{CC} ≤ 2.70	I_{OL}=18 mA		0.6		0.6	
		2.70 ≤ V_{CC} ≤ 3.60			0.4		0.4	
		2.70 ≤ V_{CC} ≤ 3.60	I_{OL}=24 mA		0.55		0.55	
I_{IN}	Input Leakage Current	0.90 to 3.60	0 ≤ V_{IN} ≤ 3.60		±0.1		±0.5	µA
I_{OZ}	3-STATE Output Leakage	0.90 to 3.6	V_{IN}=V_{IH} or V_{IL} 0 ≤ V_{IN} ≤ 3.60		±0.5		±0.5	µA
I_{OFF}	Power Off	0	0 ≤ ($V_{IN,}$ v_o) ≤ 3.60		0.5		0.5	µA
I_{CC}	Quiescent Supply Current	0.90 to 3.60	V_{IN}=V_{CC}, or GND		0.9		0.9	µA
			V_{CC} ≤ V_{IN} ≤ 3.6 V				±0.9	

AC Electrical Characteristics

Symbol	Parameter	V_{CC}	Conditions	T_A=25°C			T_A=-40 to 85°C		Units	Figure
				Min.	Typ.	Max.	Min.	Max.		
t_{PHL}, t_{PLH}	Propagation Delay	0.90	C_L=15 pF, R_L=1 MΩ		13				ns	Figure 5 Figure 6
		1.10 ≤ V_{CC} ≤ 1.30	C_L=15 pF, R_L=2 kΩ	3.0	6.0	9.8	1.9	14.9		
		1.40 ≤ V_{CC} ≤ 1.60		1.0	3.5	5.3	0.8	5.7		
		1.65 ≤ V_{CC} ≤ 1.95	C_L=30 pF, R_L=500 Ω	0.9	3.0	4.3	0.8	4.6		
		2.30 ≤ V_{CC} ≤ 2.60		0.8	1.8	2.8	0.7	3.0		
		2.70 ≤ V_{CC} ≤ 3.60		0.5	1.0	2.6	0.3	2.8		
t_{PZL},t_{PZH}	Output Enable Time	0.90	C_L=30 pF, R_U=1 kΩ R_D=1 kΩ		12				ns	
		1.10 ≤ V_{CC} ≤ 1.30		3.0	6.0	9.7	2.0	16.4	ns	Figure 5 Figure 6
		1.40 ≤ V_{CC} ≤ 1.60		1.2	4.0	6.0	1.0	7.5		
		1.65 ≤ V_{CC} ≤ 1.95		1.0	3.0	4.5	0.9	5.0		
		2.30 ≤ V_{CC} ≤ 2.60		0.8	2.0	3.0	0.7	3.4		
		2.70 ≤ V_{CC} ≤ 3.60		0.5	1.2	2.6	0.4	2.9		
t_{PHZ},t_{PLZ}	Output Disable Time	0.90	C_L=30 pF, R_U=1 kΩ R_D=1 kΩ		14				ns	Figure 5 Figure 6
		1.10 ≤ V_{CC} ≤ 1.30		2.0	5.0	9.5	2.0	14.0		
		1.40 ≤ V_{CC} ≤ 1.60		1.2	3.0	5.5	1.1	7.0		
		1.65 ≤ V_{CC} ≤ 1.95		1.0	2.0	5.6	0.8	5.8		
		2.30 ≤ V_{CC} ≤ 2.60		0.6	1.3	4.2	0.5	5.0		
		2.70 ≤ V_{CC} ≤ 3.60		0.5	1.0	3.9	0.4	4.2		
C_{IN}	Input Capacitance	0.00			2				pF	
C_{OUT}	Output Capacitance	0.00			4.5				pF	
C_{PD}	Power Dissipation Capacitance	0.90 to 3.60	V_I=0 V or V_{CC}, f=10 MHz		10				pF	

AC Loadings and Waveforms

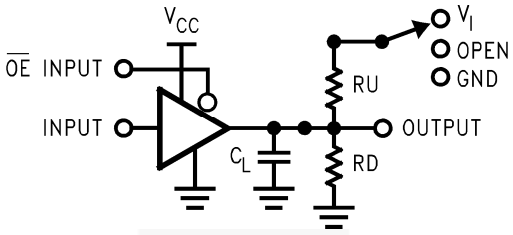


Figure 5. AC Test Circuit

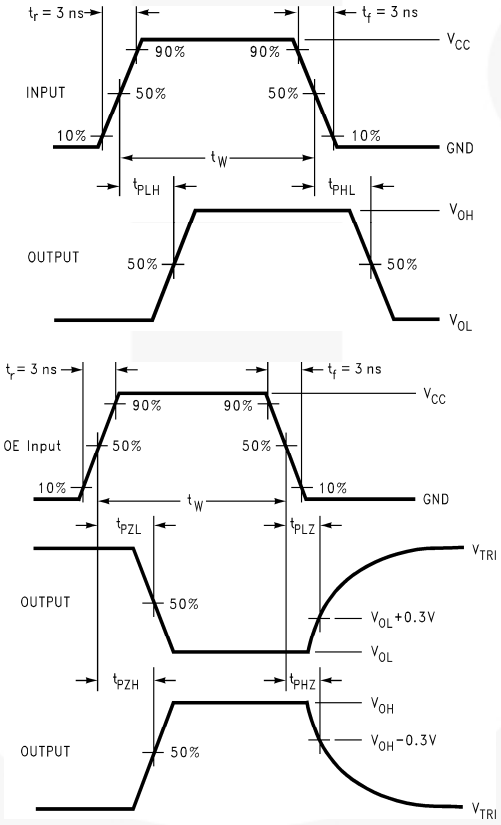


Figure 6. AC Waveforms

Physical Dimensions

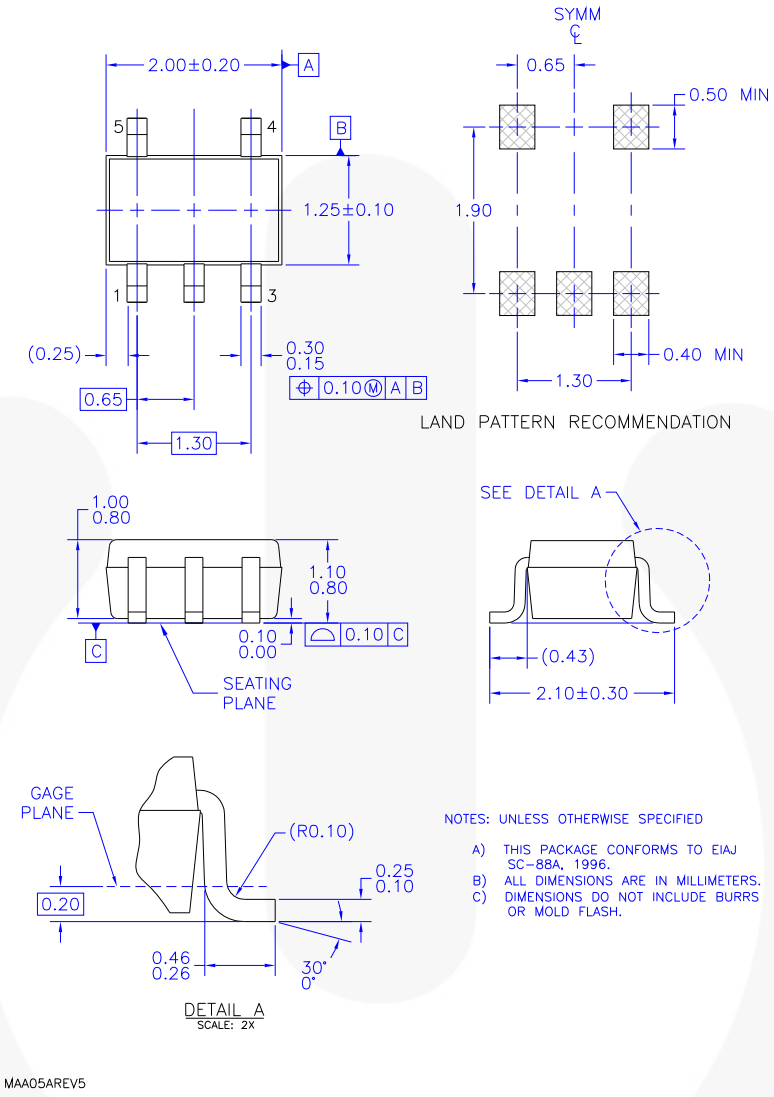


Figure 7. 5-Lead, SC70, EIAJ SC-88a, 1.25 mm Wide

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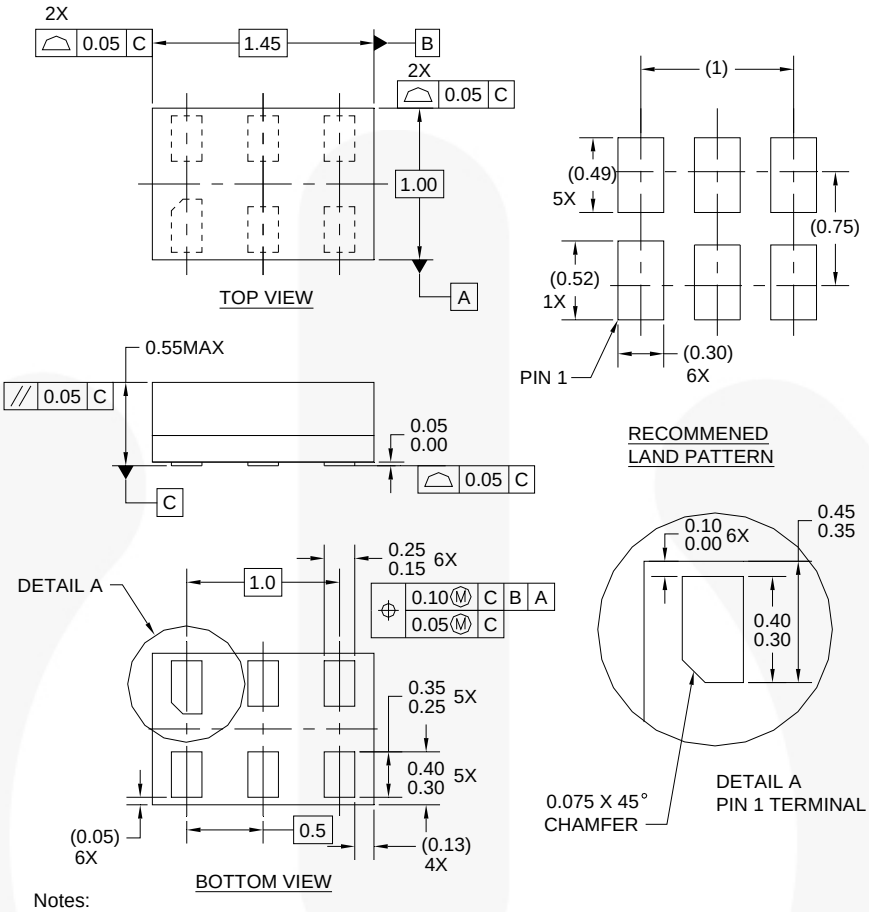
Tape and Reel Specification

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:
http://www.fairchildsemi.com/products/analog/pdf/sc70-5_tr.pdf.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
P5X	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

Physical Dimensions



Notes:

1. CONFORMS TO JEDEC STANDARD M0-252 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06AREVC

Figure 8. 6-Lead, MicroPak™, 1.0mm Wide

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Tape and Reel Specification

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:
http://www.fairchildsemi.com/products/logic/pdf/micropak_tr.pdf.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
L6X	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

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Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I68

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